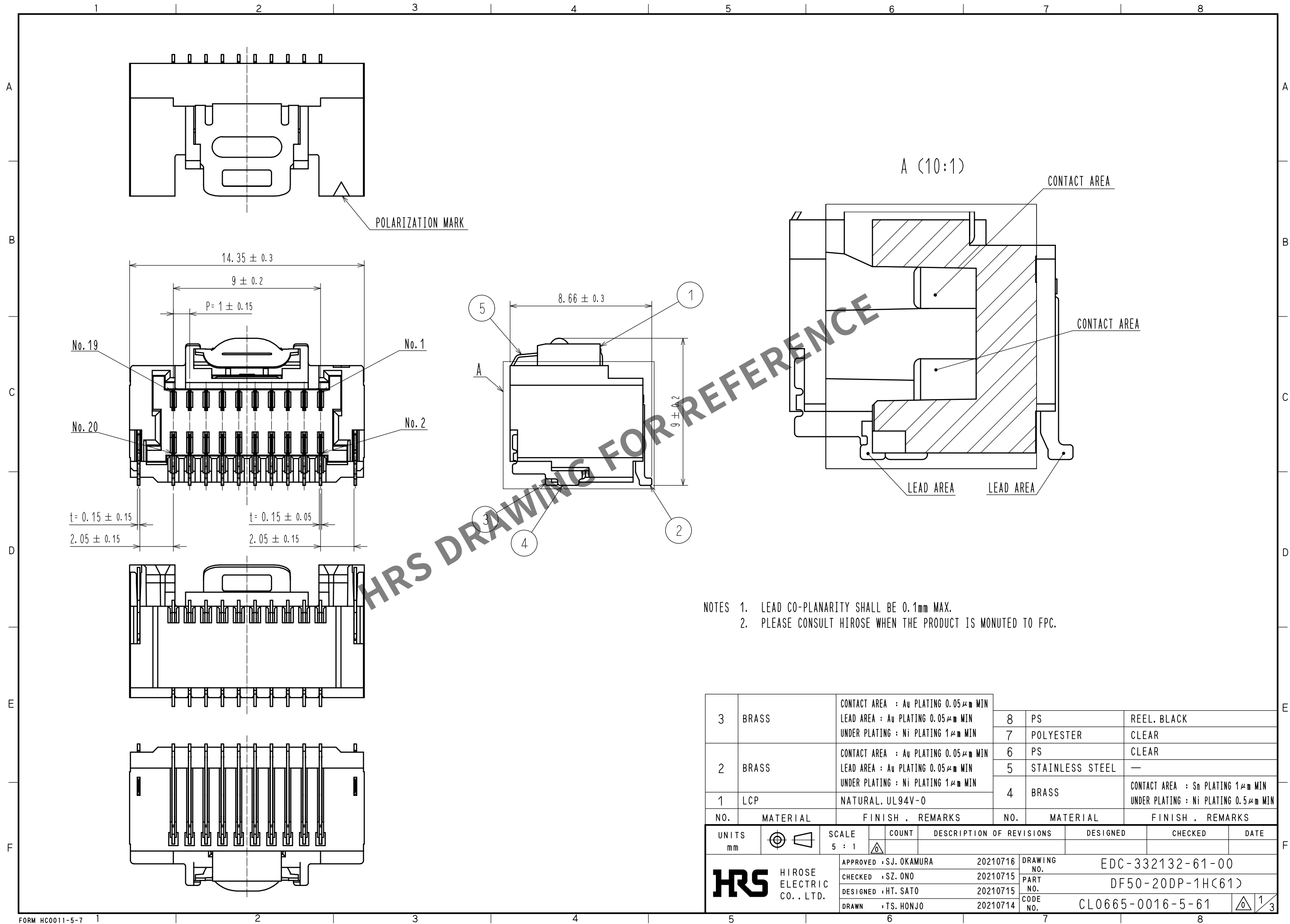
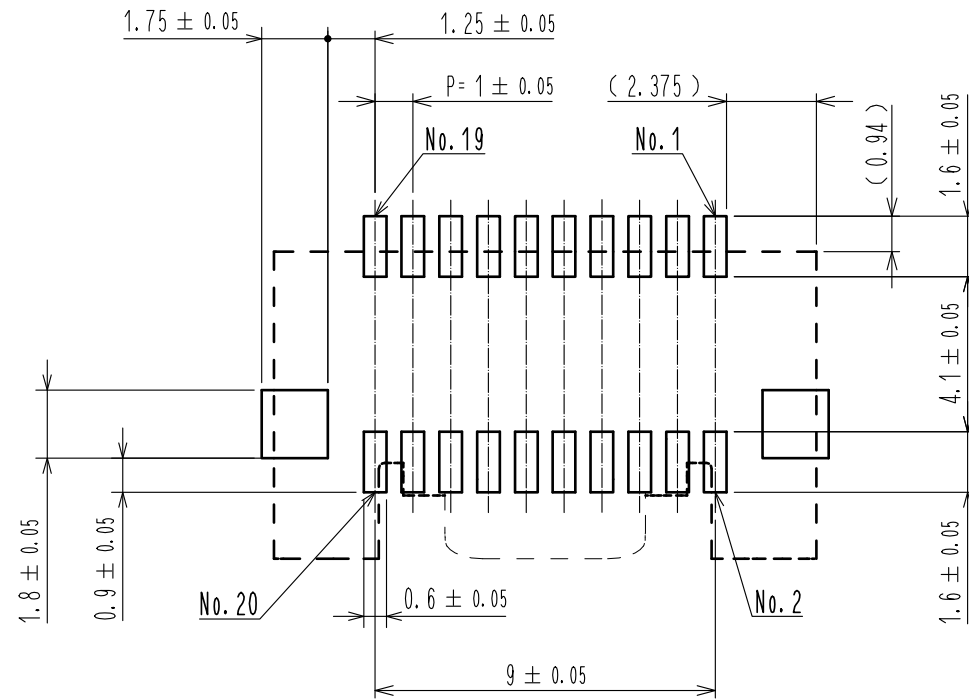


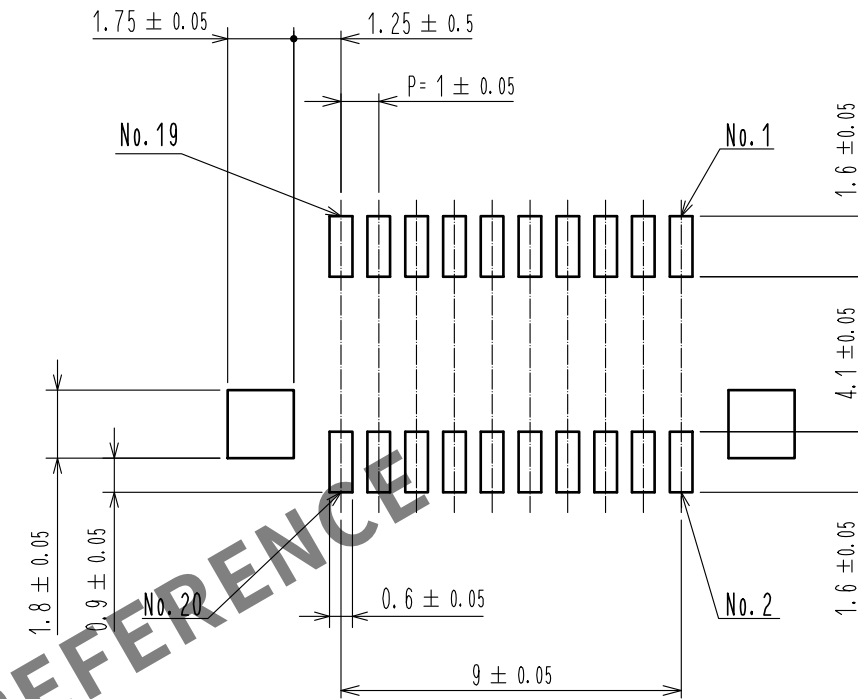


RECOMMENDED PCB LAYOUT
(MOUNTING SURFACE SIDE) (FREE)

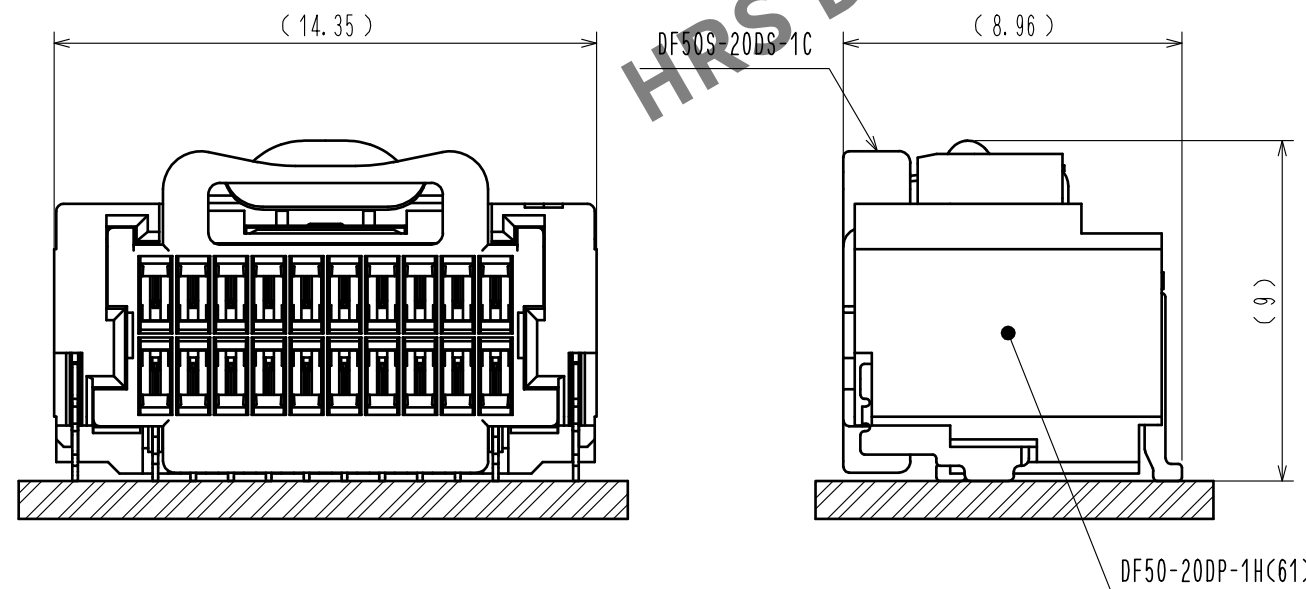


RECOMMENDED METAL MASK (FREE)

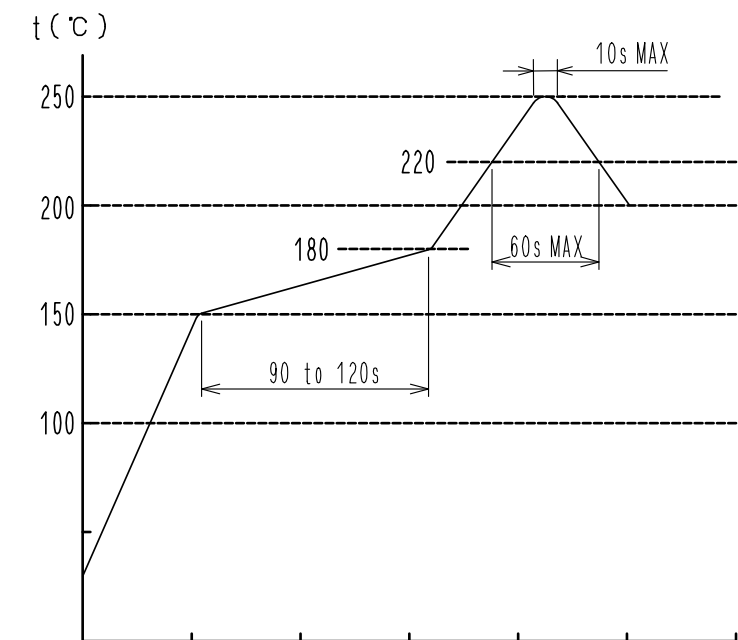
THICKNESS : 0.1mm
OPEN AREA RATIO:100%



MATING FIGURE (5:1)



REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE (REFERENCE)



NUMBER OF REFLOW CYCLES: 2 CYCLES MAX. (s)
THE TEMPERATURE IS MEASURED IN THE TERMINAL LEAD PART.
ADDITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE,
PCB SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT
THE PROFILE. THEREFORE, A THOROUGH EVALUATION OF
MOUNTING CONDITION IS REQUIRED PRIOR TO PRODUCTION.
TEMPERATURE IS MEASURED AT CONTACT LEAD.

HRS

DRAWING NO.	EDC-332132-61-00
PART NO.	DF50-20DP-1H(61)
CODE NO.	CL0665-0016-5-61

May.1.2024 Copyright 2024 HIROSE ELECTRIC CO., LTD. All Rights Reserved.
In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

